

Title (en)  
A LASER CUTTING APPARATUS

Title (de)  
LASERSCHNEIDGERÄT

Title (fr)  
APPAREIL DE DECOUPE AU LASER

Publication  
**EP 1599403 A1 20051130 (EN)**

Application  
**EP 03779580 A 20031219**

Priority  
• AU 0301703 W 20031219  
• AU 2002953443 A 20021219

Abstract (en)  
[origin: WO2004056685A1] A laser cutting apparatus (10) is provided for cutting sheet materials. The apparatus (10) includes a table bed (12) having a perforated top surface (40) for a sheet material (32) to be positioned thereon, a gantry (64) extending across the bed and arranged to travel in along the bed, and a carriage (62) arranged to travel along the gantry. The bed has a holding arrangement (46 and 48) for holding the sheet material in position on said bed. The carriage has a laser head (30) with a laser nozzle (36) and is arranged to receive a laser source (32) and to direct a laser beam (42) through the nozzle and towards the bed for cutting the sheet material. An enclosure member (52) having a first low pressure chamber (94) therein is arranged about the laser nozzle. The first chamber has a suction opening beneath the laser nozzle for entraining substantial by-products produced during cutting of the sheet material into the first chamber and for causing a part of the sheet material under the suction opening to be lifted off the top surface. A self cleaning cover (96) with spaced apertures (106) can be rotatably mounted on the enclosure member for removing by-products caught in the selected aperture (106). The carriage may have profiled crease wheels (48,50) for forming crease lines of limited depth into the sheet material. The gantry may have a gripping device (70) arranged to initially lift a small area of a leading edge of the sheet material and then progressively lift other areas of the leading edge onto its lower plate.

IPC 1-7  
**B65H 20/16**; **B65H 20/18**; **B23K 26/14**

IPC 8 full level  
**B65H 35/00** (2006.01); **B23K 26/10** (2006.01); **B23K 26/14** (2006.01); **B23K 26/16** (2006.01); **B23K 26/38** (2006.01)

CPC (source: EP)  
**B23K 26/142** (2015.10); **B23K 26/1436** (2015.10); **B23K 26/1476** (2013.01); **B23K 26/16** (2013.01); **B65H 35/0006** (2013.01); **B65H 35/002** (2013.01); **B65H 2301/51536** (2013.01)

Cited by  
US9450727B2; US8379601B2

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PT RO SE SI SK TR

DOCDB simple family (publication)  
**WO 2004056685 A1 20040708**; AU 2002953443 A0 20030109; EP 1599403 A1 20051130; EP 1599403 A4 20060607

DOCDB simple family (application)  
**AU 0301703 W 20031219**; AU 2002953443 A 20021219; EP 03779580 A 20031219